



N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE609 uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

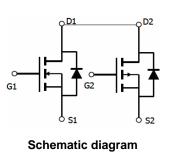
N-Channel

 $V_{DS} = 40V, I_D = 21A$ $R_{DS(ON)} < 19m\Omega @ V_{GS} = 10V$ $R_{DS(ON)} < 29m\Omega @ V_{GS} = 4.5V$

• P-Channel

$$\begin{split} V_{DS} =& -40 V, I_D = -14 A \\ R_{DS(ON)} <& 35 m \Omega @ V_{GS} =& -10 V \\ R_{DS(ON)} <& 45 m \Omega @ V_{GS} =& -4.5 V \end{split}$$

- High power and current handing capability
- Lead free product is acquired
- Surface mount package





Marking and pin assignment

100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE609	NCE609	TO-252-4L	-	-	-

Absolute Maximum Ratings (T_A=25[°]C unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V _{DS}	40	-40	V	
Gate-Source Voltage		V _{GS}	±20	±20	V	
	T _A =25℃		21	-14	٨	
Continuous Drain Current	T _A =70℃	I _D	17.5	-11.5	A	
Pulsed Drain Current ^(Note 1)		I _{DM}	40	-40	А	
Maximum Power Dissipation	T _A =25℃	PD	40	40	W	
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note2)	R _{eJC}	N-Ch	3.1	°C/W
Thermal Resistance, Junction-to-Case ^(Note2)	$R_{ extsf{ heta}JC}$	P-Ch	3.1	°C/W





N-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.5	2.0	V
Drain-Source On-State Resistance	P	V_{GS} =10V, I _D =10A	-	14	19	mΩ
	R _{DS(ON)}	V _{GS} =4.5V, I _D =5A	-	19	29	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =10A		15	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	<u>)/ -20)/)/ -0)/</u>	-	1500	-	PF
Output Capacitance	C _{oss}	V _{DS} =20V,V _{GS} =0V, F=1.0MHz	-	215	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0101HZ	-	135	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	4	-	nS
Turn-on Rise Time	tr	V_{DD} =20V, R _L =2 Ω	-	11.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =3 Ω	-	18	-	nS
Turn-Off Fall Time	t _f		-	5.6	-	nS
Total Gate Charge	Qg		-	24	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =20V,I _D =10A, V _{GS} =10V	-	4	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	3.5	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-	0.8	1.2	V





P-CH Electrical Characteristics (T_A=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-40	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-40V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	· · ·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.0	-1.5	-2.0	V
Drain Source On State Desistance	P	V_{GS} =-10V, I_D =-7A	-	29	35	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-4A	-	34	45	mΩ
Forward Transconductance	G FS	V _{DS} =-5V,I _D =-7A	-	15	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	1225	-	PF
Output Capacitance	C _{oss}	V _{DS} =-20V,V _{GS} =0V, F=1.0MHz	-	190	-	PF
Reverse Transfer Capacitance	C _{rss}		-	120	-	PF
Switching Characteristics (Note 4)	· · ·					
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V_{DD} =-20V, R _L =2.3 Ω	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{GEN} =6 Ω	-	30	-	nS
Turn-Off Fall Time	t _f		-	18	-	nS
Total Gate Charge	Qg		-	21	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-20V,I _D =-7A	-	3.5	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	3.0	-	nC
Drain-Source Diode Characteristics	- • · · · ·		ı			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-14A	_	-	-1.2	V

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \le 10$ sec.

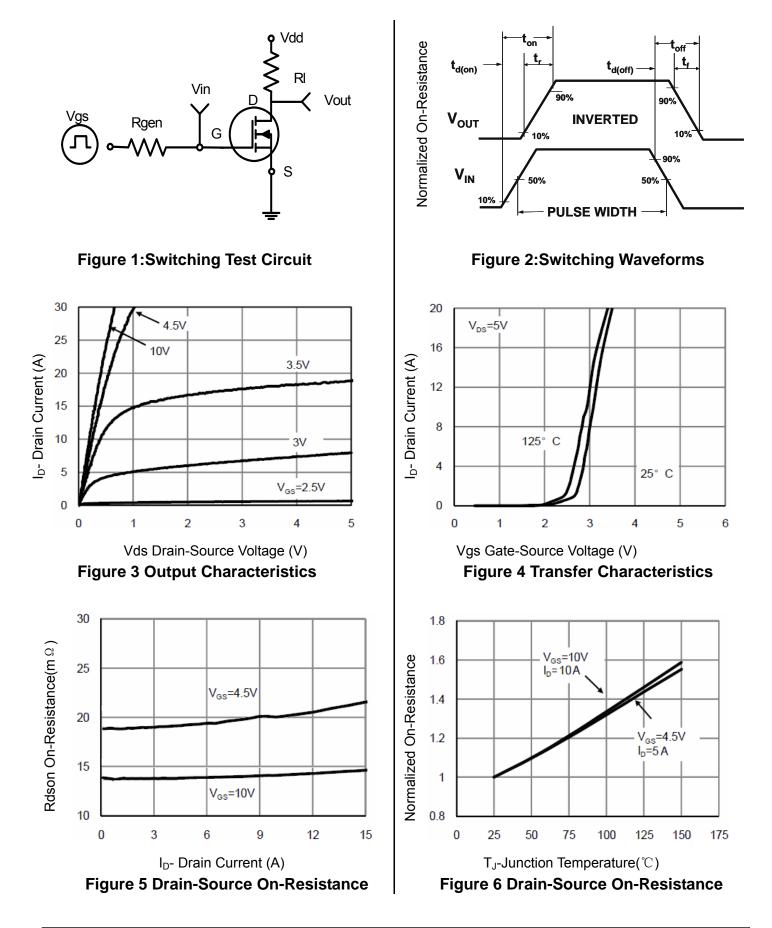
3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production





N- Channel Typical Electrical and Thermal Characteristics (Curves)





Pb Free Product

NCE609

125

1.0

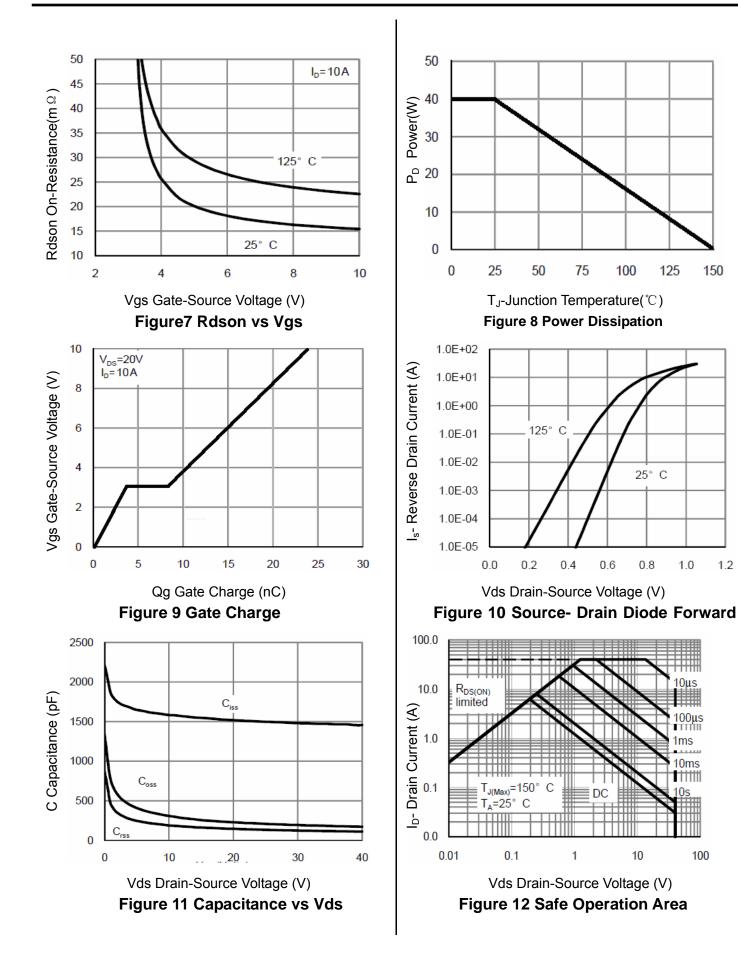
10µs

100µs

1ms

10ms 1.2

150



100







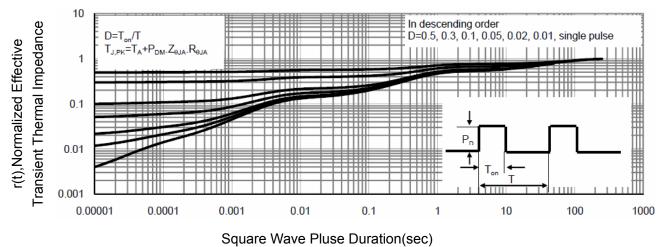
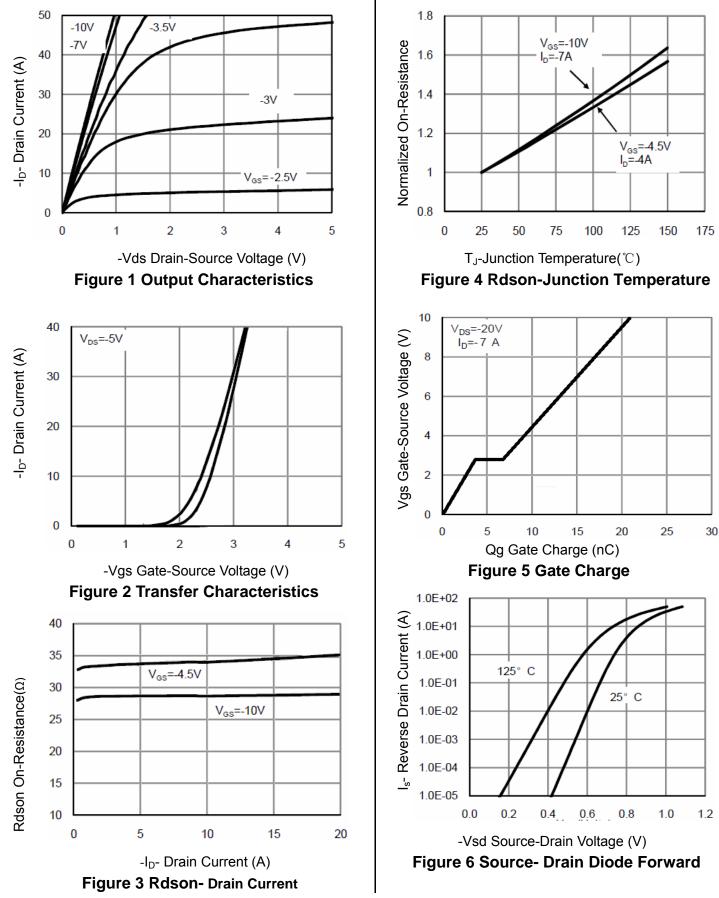


Figure 13 Normalized Maximum Transient Thermal Impedance





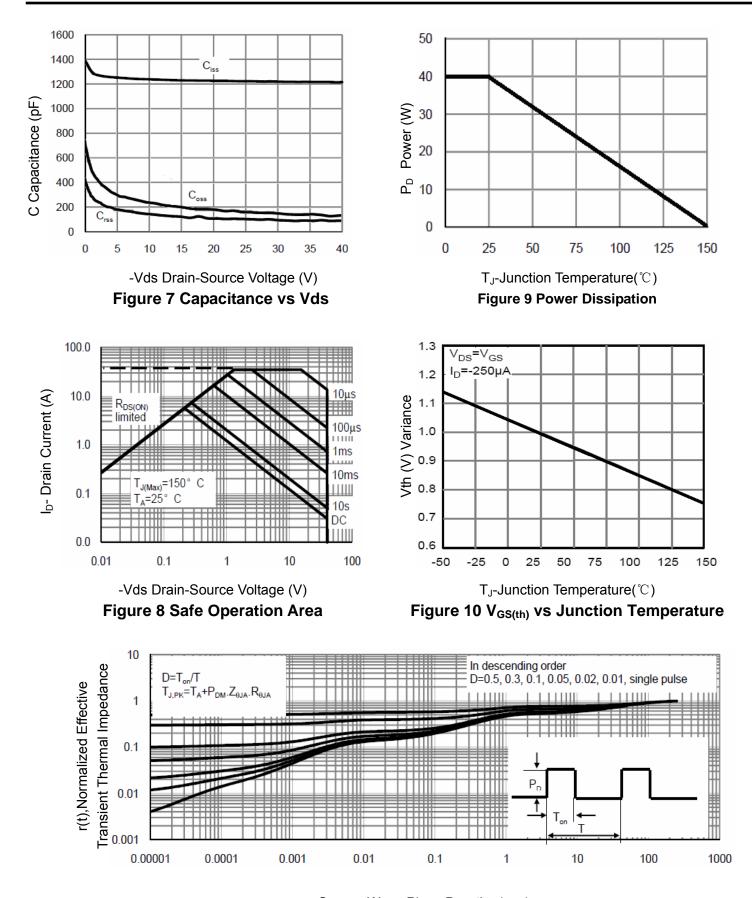
P- Channel Typical Electrical and Thermal Characteristics (Curves)











Square Wave Pluse Duration(sec)
Figure 11 Normalized Maximum Transient Thermal Impedance



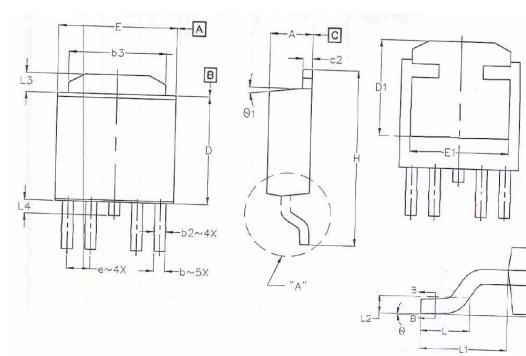




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TO-252-4L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.184	2.387	0.086	0.094	
A1	-	0.127	-	0.094	
b	0.508	0.711	0.020	0.028	
b1	0.508	0.660	0.020	0.026	
b2	0.610	0.787	0.024	0.031	
b3	4.953	5.461	0.195	0.215	
С	0.460	0.610	0.018	0.024	
c1	0.410	0.559	0.016	0.022	
C2	0.460	12.950	0.498	0.510	
D	4.980	5.180	0.196	0.204	
D1	2.650	2.950	0.104	0.116	
E	7.900	8.100	0.311	0.319	
E1	0.000	0.300	0.000	0.012	
е	12.900	13.400	0.508	0.528	
Н	2.850	3.250	0.112	0.128	
L	1.397	1.778	0.055	0.070	
L1	2.743	BSC	0.108	BSC	
L2	0.508	BSC	0.020	BSC	
L3	0.889	1.270	0.035	0.050	
L4	-	1.015	-	0.040	
θ	0.	10°	0°	10°	
θ1	0°	15°	0°	15°	







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